SN74CB3T16210 **20-BIT FET BUS SWITCH**

2.5-V/3.3-V LOW-VOLTAGE BUS SWITCH WITH 5-V-TOLERANT LEVEL SHIFT

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- **Member of the Texas Instruments** Widebus™ Family
- Output Voltage Translation Tracks V_{CC}
- **Supports Mixed-Mode Signal Operation On** All Data I/O Ports
 - 5-V Input Down to 3.3-V Output Level Shift With 3.3-V V_{CC}
 - 5-V/3.3-V Input Down to 2.5-V Output Level Shift With 2.5-V V_{CC}
- 5-V Tolerant I/Os With Device Powered Up or Powered Down
- **Bidirectional Data Flow With Near-Zero Propagation Delay**
- Low ON-State Resistance (ron) Characteristics ($r_{on} = 5 \Omega \text{ Typ}$)
- **Low Input/Output Capacitance Minimizes** Loading ($C_{io(OFF)} = 5 pF Typ$)
- **Data and Control Inputs Provide Undershoot Clamp Diodes**
- **Low Power Consumption** $(I_{CC} = 40 \mu A Max)$
- V_{CC} Operating Range From 2.3 V to 3.6 V
- Data I/Os Support 0- to 5-V Signaling Levels (0.8 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V, 3.3 V,
- Control Inputs Can Be Driven By TTL or 5-V/3.3-V CMOS Outputs
- Ioff Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per **JESD 17**
- **ESD Performance Tested Per JESD 22**
 - 2000-V Human-Body Model (A114-B, Class II)
 - 1000-V Charged-Device Model (C101)
- **Supports Digital Applications: Level** Translation, PCI Interface, USB Interface, Memory Interleaving, and Bus Isolation
- **Ideal for Low-Power Portable Equipment**

(TOP VIEW) ис П 48 1 1 OE 1A1 **∏** 2 47 1 2 OE 1A2 **∏** 3 46 1 1B1 45 1 1B2 1A3 **∏** 4 1A4 **∏** 5 **∏**1B3 44 1A5 **∏** 6 43 1 1B4 1A6 **∏** 7 42 1 1B5 GND ∏8 41 **∏** GND 1A7 **∏** 9 40 **∏** 1B6 1A8 **∏** 10 39 **1** 1B7 1A9 **∏** 38 **∏** 1B8 1A10 🛮 12 37 **∏** 1B9 2A1 **∏** 13 36 **∏** 1B10 2A2 1 14 35 1 2B1 34 1 2B2 2A3 **1** 16 33 **∏** 2B3 GND **1** 17 32 | GND 2A4 **1** 18 31 1 2B4 2A5 **∏** 19 30 **∏** 2B5 2A6 **1** 20 29 1 2B6 2A7 **1** 21 28 **∏** 2B7 27 1 2B8 2A8 **∏** 22 2A9 **□** 23 26 1 2B9 25 [] 2B10 2A10 **1** 24

DGG OR DGV PACKAGE

NC - No internal connection

description/ordering information

The SN74CB3T16210 is a high-speed TTL-compatible FET bus switch with low ON-state resistance (r_{on}), allowing for minimal propagation delay. The device fully supports mixed-mode signal operation on all data I/O ports by providing voltage translation that tracks V_{CC} . The SN74CB3T16210 supports systems using 5-V TTL, 3.3-V LVTTL, and 2.5-V CMOS switching standards, as well as user-defined switching levels (see Figure 1).



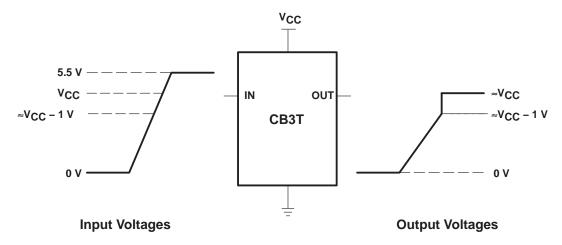
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description/ordering information (continued)



If the input high voltage (V_{IH}) level is greater than or equal to V_{CC} – 1 V, and less than or equal to 5.5 V, the output high voltage (V_{OH}) level will be equal to approximately the VCC voltage level.

Figure 1. Typical DC Voltage Translation Characteristics

The SN74CB3T16210 is organized as two 10-bit bus switches with separate ouput-enable (1OE, 2OE) inputs. It can be used as two 10-bit bus switches or as one 20-bit bus switch. When \overline{OE} is low, the associated 10-bit bus switch is ON, and the A port is connected to the B port, allowing bidirectional data flow between ports. When OE is high, the associated 10-bit bus switch is OFF, and a high-impedance state exists between the A and B ports.

This device is fully specified for partial-power-down applications using Ioff. The Ioff feature ensures that damaging current will not backflow through the device when it is powered down. The device has isolation during power off.

To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
-40°C to 85°C	TSSOP – DGG	Tape and reel	SN74CB3T16210DGGR	CB3T16210	
-40 C to 85°C	TVSOP – DGV	Tape and reel	SN74CB3T16210DGVR	KR210	

[†]Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

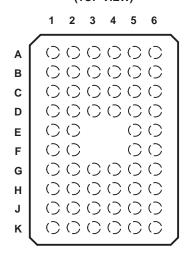
FUNCTION TABLE (each 10-bit bus switch)

INPUT OE	INPUT/OUTPUT A	FUNCTION
L	В	A port = B port
Н	Z	Disconnect



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GQL PACKAGE (TOP VIEW)

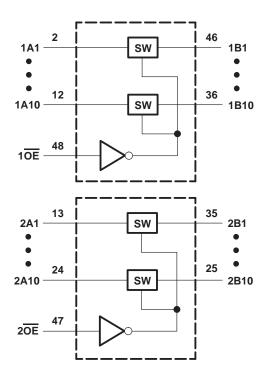


terminal assignments

_	1	2	3	4	5	6
Α	1A2	1A1	NC	1OE	2OE	1B1
В	1A5	1A4	1A3	1B2	1B3	1B4
С	NC	GND	1A6	1B5	1B6	NC
D	1A8	NC	1A7	NC	1B7	1B8
Е	1A10	1A9			1B9	1B10
F	2A1	2A2			2B2	2B1
G	VCC	GND	2A3	GND	2B4	2B3
Н	NC	NC	2A4	2B5	NC	NC
J	2A5	2A6	2A7	2B7	2B6	2B5
K	2A8	2A9	2A10	2B10	2B9	2B8

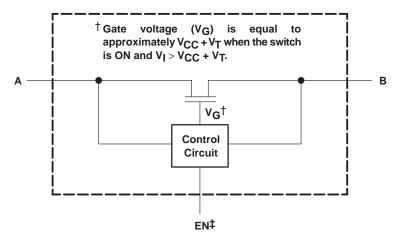
NC - No internal connection

logic diagram (positive logic)



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simplified schematic, each FET switch (SW)



[‡]EN is the internal enable signal applied to the switch.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)§

Supply voltage range, V _{CC} (see Note 1)	$-0.5 \ V$ to $7 \ V$
Control input voltage range, V _{IN} (see Notes 1 and 2)	\ldots $-0.5\ V$ to 7 V
Switch I/O voltage range, V _{I/O} (see Notes 1, 2, and 3)	\ldots $-0.5\ V$ to 7 V
Control input clamp current, I _{IK} (V _{IN} < 0)	–50 mA
I/O port clamp current, $I_{I/OK}$ ($V_{I/O}$ < 0)	–50 mA
ON-state switch current, I _{I/O} (see Note 4)	±128 mA
Continuous current through V _{CC} or GND terminals	±100 mA
Package thermal impedance, θ _{JA} (see Note 5): DGG package	70°C/W
DGV package	58°C/W
Storage temperature range, T _{stq}	65°C to 150°C

[§] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltages are with respect to ground, unless otherwise specified.
 - 2. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 - 3. V_I and V_O are used to denote specific conditions for V_{I/O}.
 - 4. II and IO are used to denote specific conditions for II/O.
 - 5. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 6)

		MIN	MAX	UNIT
Vcc	Supply voltage	2.3	3.6	V
.,	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		5.5	.,
VIH	High-level control input voltage $V_{CC} = 2.7 \text{ V to } 3.6$	V 2	5.5	V
.,	Low-level control input voltage $ \frac{V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}}{V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}} $	V 0	0.7	.,
VIL		V 0	0.8	٧
V _{I/O}	Data input/output voltage	0	5.5	V
TA	Operating free-air temperature	-40	85	°C

NOTE 6: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



2.5-V/3.3-V LOW-VOLTAGE BUS SWITCH WITH 5-V-TOLERANT LEVEL SHIFTER SCDS156A - OCTOBER 2003 - REVISED AUGUST 2004

electrical characteristics

		TEGT GOLDSTIONS		T _A = -	40°C TO	85°C	
PAI	RAMETER	TEST CONDITION	NS	MIN	TYP [†]	MAX	UNIT
VIK		V _{CC} = 3 V, I _I = -18 mA				-1.2	V
Vон		See Figures 3 and 4					
I _{IN}	Control inputs	V _{CC} = 3.6 V, V _{IN} = 3.6 V to 5.5 V or GND	V, V _{IN} = 3.6 V to 5.5 V or GND			±10	μΑ
		V _{CC} = 3.6 V,	$V_I = V_{CC} - 0.7 \text{ V to } 5.5 \text{ V}$			±20	
l _i		Switch ON,	$V_{I} = 0.7 \text{ V to } V_{CC} - 0.7 \text{ V}$			-40	μΑ
		$V_{IN} = V_{CC}$ or GND	V _I = 0 to 0.7 V			±5	
loz [‡]	$V_{CC} = 3.6 \text{ V}, V_{O} = 0 \text{ to } 5.5 \text{ V}, V_{I} = 0$, Switch OFF, $V_{IN} = V_{CC}$ or GND				±10	μΑ	
l _{off}	off $V_{CC} = 0, V_{O} = 0 \text{ to } 5.5 \text{ V}, V_{I} = 0,$				10	μΑ	
		$V_{CC} = 3.6 \text{ V}, I_{I/O} = 0,$	$V_I = V_{CC}$ or GND	40			
Icc		Switch ON or OFF, $V_{IN} = V_{CC}$ or GND	V _I = 5.5 V			40	μΑ
Δlcc§	Control inputs	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$, One input at $V_{CC} - 0.6 \text{ V}$	6 V, One input at V _{CC} – 0.6 V, Other inputs at V _{CC} or GND			300	μΑ
C _{in}	Control inputs	$V_{CC} = 3.3 \text{ V}, V_{IN} = V_{CC} \text{ or GND}$			4		pF
C _{io(OFF)}		$V_{CC} = 3.3 \text{ V}, V_{I/O} = 5.5 \text{ V}, 3.3 \text{ V}, \text{ or GND, Sw}$	vitch OFF, V _{IN} = V _{CC} or GND		5		pF
			V _{I/O} = 5.5 V or 3.3 V	5			_
C _{io(ON)}		$V_{CC} = 3.3 \text{ V}$, Switch ON, $V_{IN} = V_{CC}$ or GND	$V_{I/O} = GND$		13		pF
		V 00 V TVD 11 V 05 V V 0	$CC = 2.3 \text{ V, TYP at V}_{CC} = 2.5 \text{ V, V}_{I} = 0$ $I_{O} = 24 \text{ mA}$ $I_{O} = 16 \text{ mA}$		5	9.5	
_ ¶		$VCC = 2.3 \text{ V, } 11P \text{ at } VCC = 2.5 \text{ V, } V_1 = 0$			5	9.5	0
ron¶		V 0VV 0	I _O = 64 mA		5	8.5	Ω
		$V_{CC} = 3 \text{ V}, V_{I} = 0$	$V_{I} = 0 \text{ to } 0.7 \text{ V}$ $OFF, V_{IN} = V_{CC} \text{ or } GND$ $V_{I} = V_{CC} \text{ or } GND$ $V_{I} = 5.5 \text{ V}$ $Other inputs at V_{CC} \text{ or } GND$ 4 $itch OFF, V_{IN} = V_{CC} \text{ or } GND$ $V_{I/O} = 5.5 \text{ V or } 3.3 \text{ V}$ $V_{I/O} = GND$ 13 $I_{O} = 24 \text{ mA}$ $I_{O} = 16 \text{ mA}$ 5	8.5			

 $V_{\mbox{\footnotesize{IN}}}$ and $I_{\mbox{\footnotesize{IN}}}$ refer to control inputs. $V_{\mbox{\footnotesize{I}}},~V_{\mbox{\footnotesize{O}}},~I_{\mbox{\footnotesize{I}}},~and~I_{\mbox{\footnotesize{O}}}$ refer to data pins.

switching characteristics for V_{CC} = 2.5 V \pm 0.2 V (see Figure 2)

PARAMETER	FROM	TO	_ U.2 V		V _{CC} = 3.3 V ± 0.3 V		UNIT
	(INPUT)		MIN	MAX			
t _{pd} †	A or B	B or A		0.15		0.25	ns
^t en	ŌE	A or B	1	12	1	10	ns
^t dis	ŌĒ	A or B	1	7.5	1	8.5	ns

[†] The propagation delay is the calculated RC time constant of the typical ON-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).



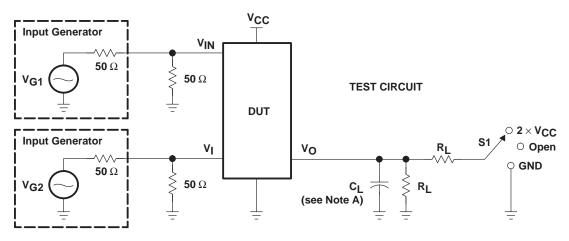
[†] All typical values are at V_{CC} = 3.3 V (unless otherwise noted), T_A = 25°C. ‡ For I/O ports, the parameter I_{OZ} includes the input leakage current.

[§] This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V_{CC} or GND.

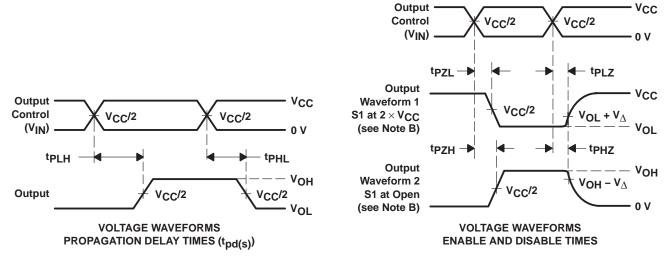
[¶] Measured by the voltage drop between A and B terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

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PARAMETER MEASUREMENT INFORMATION



TEST	VCC	S1	RL	VI	CL	$v_{\!\scriptscriptstyle\Delta}$
^t pd(s)	$2.5~V \pm 0.2~V \ 3.3~V \pm 0.3~V \$	Open Open	500 Ω 500 Ω	3.6 V or GND 5.5 V or GND	30 pF 50 pF	
tPLZ/tPZL	2.5 V ± 0.2 V 3.3 V ± 0.3 V	2×VCC 2×VCC	500 Ω 500 Ω	GND GND	30 pF 50 pF	0.15 V 0.3 V
tPHZ/tPZH	$\begin{array}{c} \textbf{2.5 V} \pm \textbf{0.2 V} \\ \textbf{3.3 V} \pm \textbf{0.3 V} \end{array}$	Open Open	500 Ω 500 Ω	3.6 V 5.5 V	30 pF 50 pF	0.15 V 0.3 V



NOTES: A. C_L includes probe and jig capacitance.

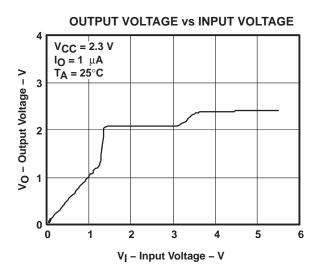
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z $_{O}$ = 50 $\Omega,\,t_{f}$ \leq 2.5 ns, t_{f} \leq 2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tplH and tpHL are the same as tpd(s). The tpd propagation delay is the calculated RC time constant of the typical ON-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).
- H. All parameters and waveforms are not applicable to all devices.

Figure 2. Test Circuit and Voltage Waveforms



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TYPICAL CHARACTERISTICS



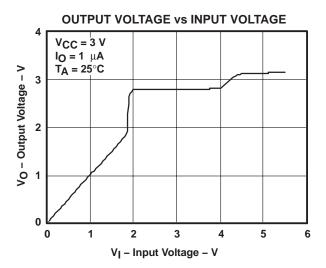
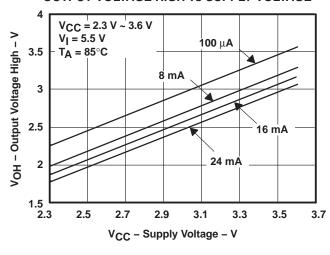


Figure 3. Data Output Voltage vs Data Input Voltage

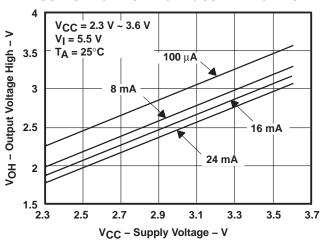
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TYPICAL CHARACTERISTICS

OUTPUT VOLTAGE HIGH vs SUPPLY VOLTAGE



OUTPUT VOLTAGE HIGH vs SUPPLY VOLTAGE



OUTPUT VOLTAGE HIGH vs SUPPLY VOLTAGE

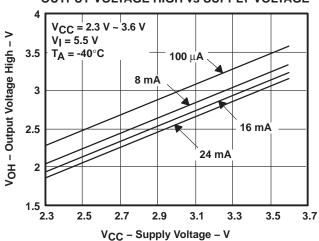


Figure 4. V_{OH} Values



DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194



DL (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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